

# NX3L1G3157

## Low-ohmic single-pole double-throw analog switch

Rev. 10 — 7 August 2012

Product data sheet

### 1. General description

The NX3L1G3157 is a low-ohmic single-pole double-throw analog switch suitable for use as an analog or digital 2:1 multiplexer/demultiplexer. It has a digital select input (S), two independent inputs/outputs (Y0 and Y1) and a common input/output (Z). Schmitt trigger action at the digital input makes the circuit tolerant to slower input rise and fall times.

The NX3L1G3157 allows signals with amplitude up to  $V_{CC}$  to be transmitted from Z to Y0 or Y1; or from Y0 or Y1 to Z. Its low ON resistance ( $0.5\ \Omega$ ) and flatness ( $0.13\ \Omega$ ) ensures minimal attenuation and distortion of transmitted signals.

### 2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance:
  - ◆  $1.6\ \Omega$  (typical) at  $V_{CC} = 1.4\text{ V}$
  - ◆  $1.0\ \Omega$  (typical) at  $V_{CC} = 1.65\text{ V}$
  - ◆  $0.55\ \Omega$  (typical) at  $V_{CC} = 2.3\text{ V}$
  - ◆  $0.50\ \Omega$  (typical) at  $V_{CC} = 2.7\text{ V}$
  - ◆  $0.50\ \Omega$  (typical) at  $V_{CC} = 4.3\text{ V}$
- Break-before-make switching
- High noise immunity
- ESD protection:
  - ◆ HBM JESD22-A114F Class 3A exceeds 7500 V
  - ◆ MM JESD22-A115-A exceeds 200 V
  - ◆ CDM AEC-Q100-011 revision B exceeds 1000 V
  - ◆ IEC61000-4-2 contact discharge exceeds 8000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD78 Class II Level A
- Direct interface with TTL levels at 3.0 V
- Control input accepts voltages above supply voltage
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and from  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$



3. Applications

- Cell phone
- PDA
- Portable media player

4. Ordering information

Table 1. Ordering information

| Type number  | Package           |       |                                                                                             |         |
|--------------|-------------------|-------|---------------------------------------------------------------------------------------------|---------|
|              | Temperature range | Name  | Description                                                                                 | Version |
| NX3L1G3157GW | −40 °C to +125 °C | SC-88 | plastic surface-mounted package; 6 leads                                                    | SOT363  |
| NX3L1G3157GM | −40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm | SOT886  |

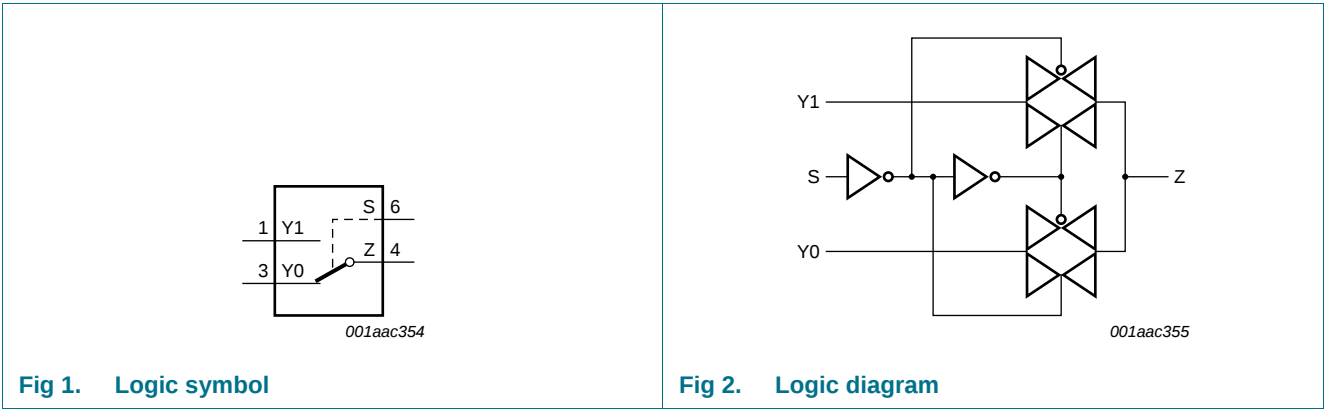
5. Marking

Table 2. Marking codes<sup>[1]</sup>

| Type number  | Marking code |
|--------------|--------------|
| NX3L1G3157GW | MJ           |
| NX3L1G3157GM | MJ           |

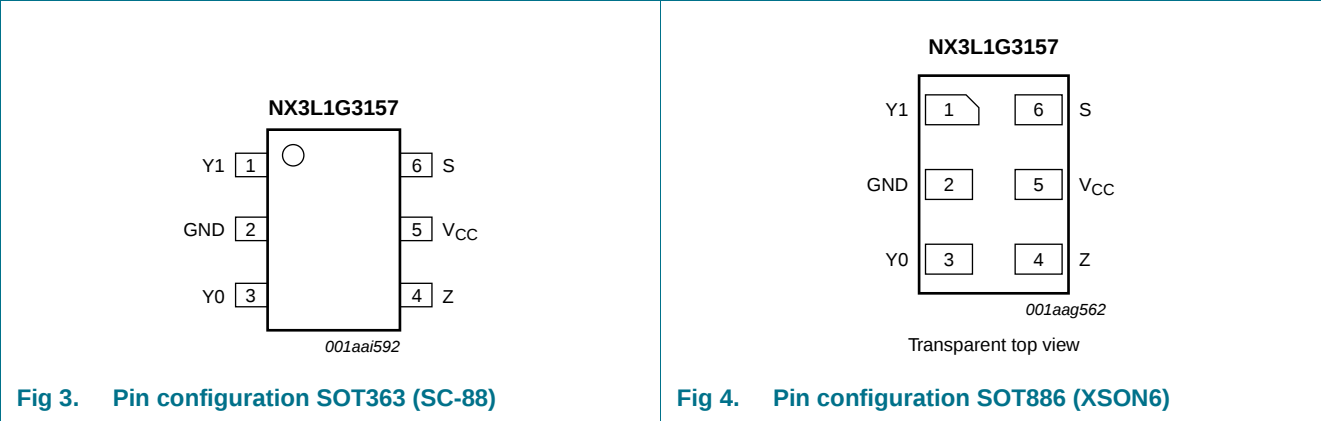
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram



7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

| Symbol          | Pin | Description                 |
|-----------------|-----|-----------------------------|
| Y1              | 1   | independent input or output |
| GND             | 2   | ground (0 V)                |
| Y0              | 3   | independent input or output |
| Z               | 4   | common output or input      |
| V <sub>CC</sub> | 5   | supply voltage              |
| S               | 6   | select input                |

8. Functional description

Table 4. Function table<sup>[1]</sup>

| Input S | Channel on |
|---------|------------|
| L       | Y0         |
| H       | Y1         |

[1] H = HIGH voltage level; L = LOW voltage level.

## 9. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                                                                                                     | Min      | Max            | Unit |
|-----------|-------------------------|----------------------------------------------------------------------------------------------------------------|----------|----------------|------|
| $V_{CC}$  | supply voltage          |                                                                                                                | -0.5     | +4.6           | V    |
| $V_I$     | input voltage           | select input S                                                                                                 | [1] -0.5 | +4.6           | V    |
| $V_{SW}$  | switch voltage          |                                                                                                                | [2] -0.5 | $V_{CC} + 0.5$ | V    |
| $I_{IK}$  | input clamping current  | $V_I < -0.5$ V                                                                                                 | -50      | -              | mA   |
| $I_{SK}$  | switch clamping current | $V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V                                                                       | -        | $\pm 50$       | mA   |
| $I_{SW}$  | switch current          | $V_{SW} > -0.5$ V or $V_{SW} < V_{CC} + 0.5$ V;<br>source or sink current                                      | -        | $\pm 350$      | mA   |
|           |                         | $V_{SW} > -0.5$ V or $V_{SW} < V_{CC} + 0.5$ V;<br>pulsed at 1 ms duration, < 10 % duty cycle;<br>peak current | -        | $\pm 500$      | mA   |
| $T_{stg}$ | storage temperature     |                                                                                                                | -65      | +150           | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to +125 °C                                                                                  | [3] -    | 250            | mW   |

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For SC-88 package: above 87.5 °C the value of  $P_{tot}$  derates linearly with 4.0 mW/K.  
For XSON6 package: above 118 °C the value of  $P_{tot}$  derates linearly with 7.8 mW/K.

## 10. Recommended operating conditions

**Table 6. Recommended operating conditions**

| Symbol              | Parameter                           | Conditions                | Min   | Max      | Unit |
|---------------------|-------------------------------------|---------------------------|-------|----------|------|
| $V_{CC}$            | supply voltage                      |                           | 1.4   | 4.3      | V    |
| $V_I$               | input voltage                       | select input S            | 0     | 4.3      | V    |
| $V_{SW}$            | switch voltage                      |                           | [1] 0 | $V_{CC}$ | V    |
| $T_{amb}$           | ambient temperature                 |                           | -40   | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 1.4$ V to 4.3 V | [2] - | 200      | ns/V |

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current flows from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

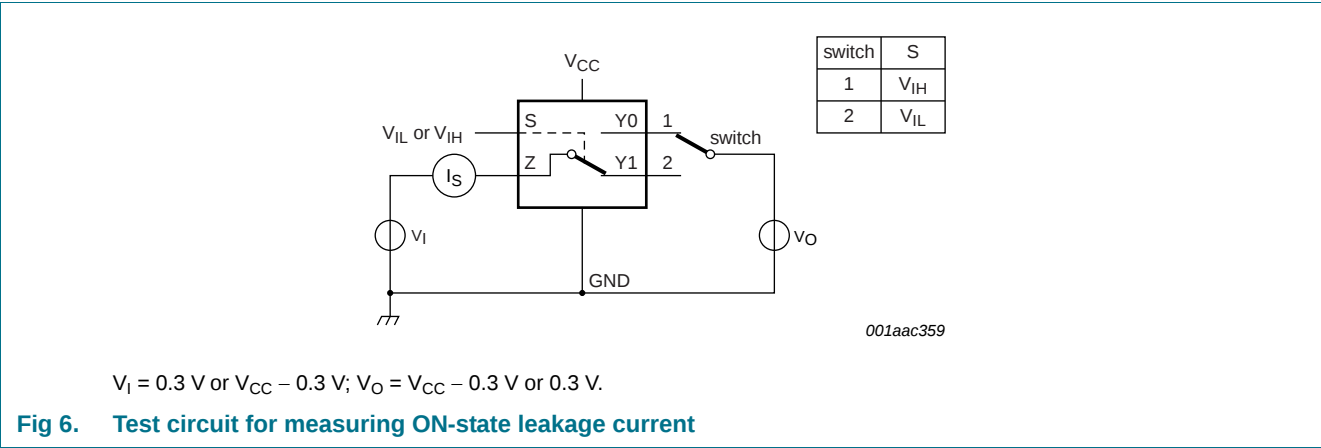
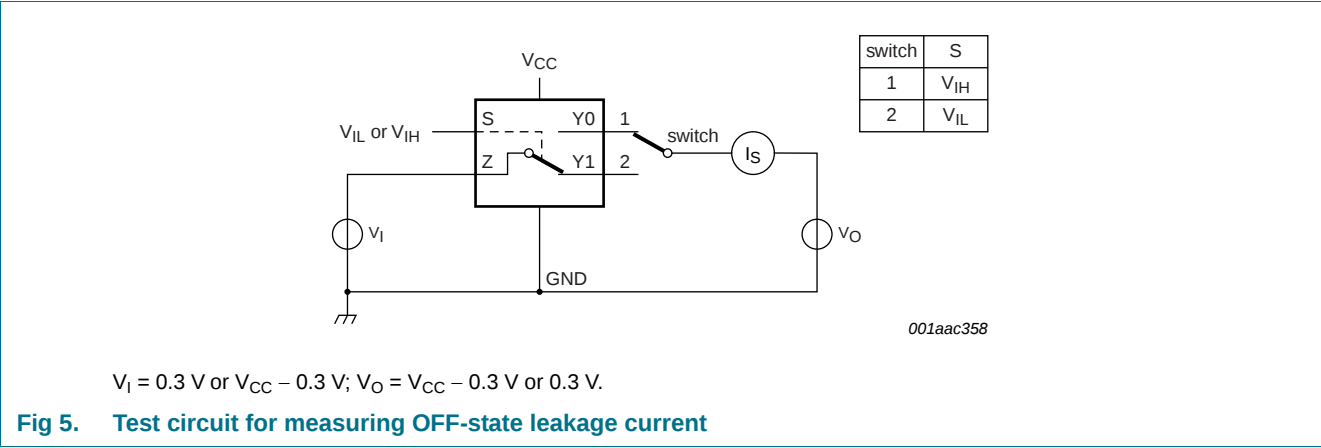
## 11. Static characteristics

**Table 7. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

| Symbol              | Parameter                 | Conditions                                                                            | T <sub>amb</sub> = 25 °C |     |                     | T <sub>amb</sub> = –40 °C to +125 °C |                     |                     | Unit |
|---------------------|---------------------------|---------------------------------------------------------------------------------------|--------------------------|-----|---------------------|--------------------------------------|---------------------|---------------------|------|
|                     |                           |                                                                                       | Min                      | Typ | Max                 | Min                                  | Max (85 °C)         | Max (125 °C)        |      |
| V <sub>IH</sub>     | HIGH-level input voltage  | V <sub>CC</sub> = 1.4 V to 1.95 V                                                     | 0.65V <sub>CC</sub>      | -   | -                   | 0.65V <sub>CC</sub>                  | -                   | -                   | V    |
|                     |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                                      | 1.7                      | -   | -                   | 1.7                                  | -                   | -                   | V    |
|                     |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                                      | 2.0                      | -   | -                   | 2.0                                  | -                   | -                   | V    |
|                     |                           | V <sub>CC</sub> = 3.6 V to 4.3 V                                                      | 0.7V <sub>CC</sub>       | -   | -                   | 0.7V <sub>CC</sub>                   | -                   | -                   | V    |
| V <sub>IL</sub>     | LOW-level input voltage   | V <sub>CC</sub> = 1.4 V to 1.95 V                                                     | -                        | -   | 0.35V <sub>CC</sub> | -                                    | 0.35V <sub>CC</sub> | 0.35V <sub>CC</sub> | V    |
|                     |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                                      | -                        | -   | 0.7                 | -                                    | 0.7                 | 0.7                 | V    |
|                     |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                                      | -                        | -   | 0.8                 | -                                    | 0.8                 | 0.8                 | V    |
|                     |                           | V <sub>CC</sub> = 3.6 V to 4.3 V                                                      | -                        | -   | 0.3V <sub>CC</sub>  | -                                    | 0.3V <sub>CC</sub>  | 0.3V <sub>CC</sub>  | V    |
| I <sub>I</sub>      | input leakage current     | select input S;<br>V <sub>I</sub> = GND to 4.3 V;<br>V <sub>CC</sub> = 1.4 V to 4.3 V | -                        | -   | -                   | -                                    | ±0.5                | ±1                  | μA   |
| I <sub>S(OFF)</sub> | OFF-state leakage current | Y0 and Y1 port;<br>see <a href="#">Figure 5</a>                                       |                          |     |                     |                                      |                     |                     |      |
|                     |                           | V <sub>CC</sub> = 1.4 V to 3.6 V                                                      | -                        | -   | ±5                  | -                                    | ±50                 | ±500                | nA   |
|                     |                           | V <sub>CC</sub> = 3.6 V to 4.3 V                                                      | -                        | -   | ±10                 | -                                    | ±50                 | ±500                | nA   |
| I <sub>S(ON)</sub>  | ON-state leakage current  | Z port; see <a href="#">Figure 6</a>                                                  |                          |     |                     |                                      |                     |                     |      |
|                     |                           | V <sub>CC</sub> = 1.4 V to 3.6 V                                                      | -                        | -   | ±5                  | -                                    | ±50                 | ±500                | nA   |
|                     |                           | V <sub>CC</sub> = 3.6 V to 4.3 V                                                      | -                        | -   | ±10                 | -                                    | ±50                 | ±500                | nA   |
| I <sub>CC</sub>     | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND;<br>V <sub>SW</sub> = GND or V <sub>CC</sub>  |                          |     |                     |                                      |                     |                     |      |
|                     |                           | V <sub>CC</sub> = 3.6 V                                                               | -                        | -   | 100                 | -                                    | 690                 | 6000                | nA   |
|                     |                           | V <sub>CC</sub> = 4.3 V                                                               | -                        | -   | 150                 | -                                    | 800                 | 7000                | nA   |
| C <sub>I</sub>      | input capacitance         |                                                                                       | -                        | 1.0 | -                   | -                                    | -                   | -                   | pF   |
| C <sub>S(OFF)</sub> | OFF-state capacitance     |                                                                                       | -                        | 35  | -                   | -                                    | -                   | -                   | pF   |
| C <sub>S(ON)</sub>  | ON-state capacitance      |                                                                                       | -                        | 130 | -                   | -                                    | -                   | -                   | pF   |

11.1 Test circuits



## 11.2 ON resistance

**Table 8. ON resistance**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see [Figure 8](#) to [Figure 14](#).

| Symbol                | Parameter                               | Conditions                                                                                             | T <sub>amb</sub> = −40 °C to +85 °C |                    |       | T <sub>amb</sub> = −40 °C to +125 °C |      | Unit |
|-----------------------|-----------------------------------------|--------------------------------------------------------------------------------------------------------|-------------------------------------|--------------------|-------|--------------------------------------|------|------|
|                       |                                         |                                                                                                        | Min                                 | Typ <sup>[1]</sup> | Max   | Min                                  | Max  |      |
| R <sub>ON(peak)</sub> | ON resistance (peak)                    | V <sub>I</sub> = GND to V <sub>CC</sub> ;<br>I <sub>SW</sub> = 100 mA;<br>see <a href="#">Figure 7</a> |                                     |                    |       |                                      |      |      |
|                       |                                         | V <sub>CC</sub> = 1.4 V                                                                                | -                                   | 1.6                | 3.7   | -                                    | 4.1  | Ω    |
|                       |                                         | V <sub>CC</sub> = 1.65 V                                                                               | -                                   | 1.0                | 1.6   | -                                    | 1.7  | Ω    |
|                       |                                         | V <sub>CC</sub> = 2.3 V                                                                                | -                                   | 0.55               | 0.8   | -                                    | 0.9  | Ω    |
|                       |                                         | V <sub>CC</sub> = 2.7 V                                                                                | -                                   | 0.5                | 0.75  | -                                    | 0.9  | Ω    |
|                       |                                         | V <sub>CC</sub> = 4.3 V                                                                                | -                                   | 0.5                | 0.75  | -                                    | 0.9  | Ω    |
| ΔR <sub>ON</sub>      | ON resistance mismatch between channels | V <sub>I</sub> = GND to V <sub>CC</sub> ;<br>I <sub>SW</sub> = 100 mA                                  | <a href="#">[2]</a>                 |                    |       |                                      |      |      |
|                       |                                         | V <sub>CC</sub> = 1.4 V                                                                                | -                                   | 0.04               | 0.3   | -                                    | 0.3  | Ω    |
|                       |                                         | V <sub>CC</sub> = 1.65 V                                                                               | -                                   | 0.04               | 0.2   | -                                    | 0.3  | Ω    |
|                       |                                         | V <sub>CC</sub> = 2.3 V                                                                                | -                                   | 0.02               | 0.08  | -                                    | 0.1  | Ω    |
|                       |                                         | V <sub>CC</sub> = 2.7 V                                                                                | -                                   | 0.02               | 0.075 | -                                    | 0.1  | Ω    |
|                       |                                         | V <sub>CC</sub> = 4.3 V                                                                                | -                                   | 0.02               | 0.075 | -                                    | 0.1  | Ω    |
| R <sub>ON(flat)</sub> | ON resistance (flatness)                | V <sub>I</sub> = GND to V <sub>CC</sub> ;<br>I <sub>SW</sub> = 100 mA                                  | <a href="#">[3]</a>                 |                    |       |                                      |      |      |
|                       |                                         | V <sub>CC</sub> = 1.4 V                                                                                | -                                   | 1.0                | 3.3   | -                                    | 3.6  | Ω    |
|                       |                                         | V <sub>CC</sub> = 1.65 V                                                                               | -                                   | 0.5                | 1.2   | -                                    | 1.3  | Ω    |
|                       |                                         | V <sub>CC</sub> = 2.3 V                                                                                | -                                   | 0.15               | 0.3   | -                                    | 0.35 | Ω    |
|                       |                                         | V <sub>CC</sub> = 2.7 V                                                                                | -                                   | 0.13               | 0.3   | -                                    | 0.35 | Ω    |
|                       |                                         | V <sub>CC</sub> = 4.3 V                                                                                | -                                   | 0.2                | 0.4   | -                                    | 0.45 | Ω    |

[1] Typical values are measured at T<sub>amb</sub> = 25 °C.

[2] Measured at identical V<sub>CC</sub>, temperature and input voltage.

[3] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

11.3 ON resistance test circuit and graphs

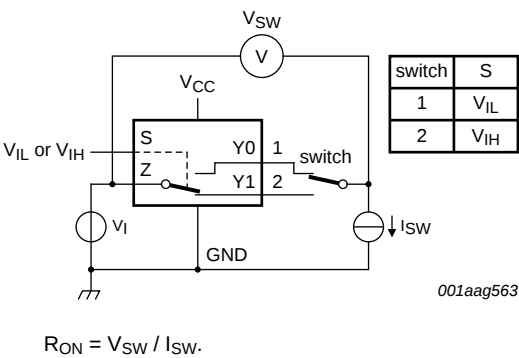
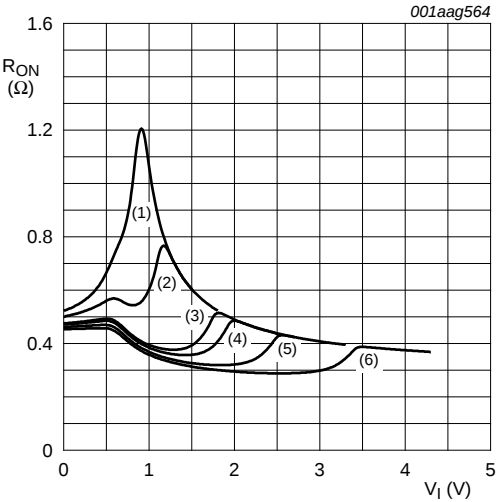
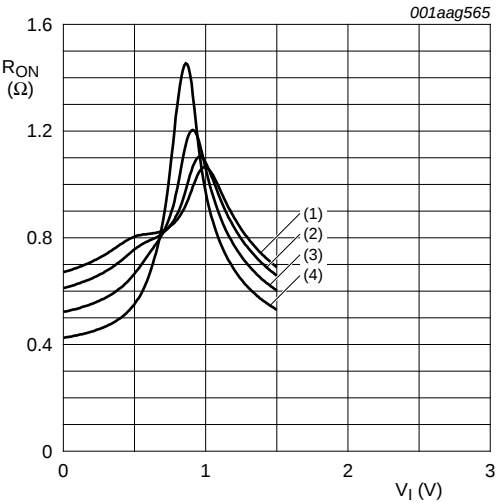


Fig 7. Test circuit for measuring ON resistance



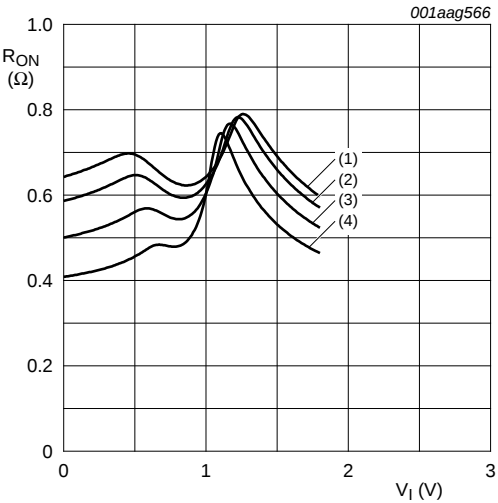
- (1)  $V_{CC} = 1.5\text{ V}$ .
  - (2)  $V_{CC} = 1.8\text{ V}$ .
  - (3)  $V_{CC} = 2.5\text{ V}$ .
  - (4)  $V_{CC} = 2.7\text{ V}$ .
  - (5)  $V_{CC} = 3.3\text{ V}$ .
  - (6)  $V_{CC} = 4.3\text{ V}$ .
- Measured at  $T_{amb} = 25\text{ }^{\circ}\text{C}$ .

Fig 8. Typical ON resistance as a function of input voltage



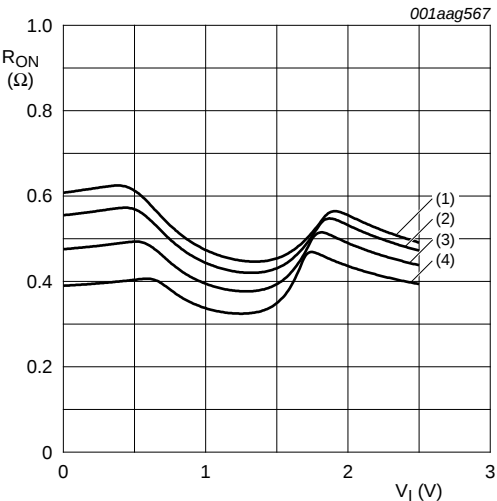
- (1)  $T_{amb} = 125\text{ }^{\circ}\text{C}.$
- (2)  $T_{amb} = 85\text{ }^{\circ}\text{C}.$
- (3)  $T_{amb} = 25\text{ }^{\circ}\text{C}.$
- (4)  $T_{amb} = -40\text{ }^{\circ}\text{C}.$

Fig 9. ON resistance as a function of input voltage;  
 $V_{CC} = 1.5\text{ V}$



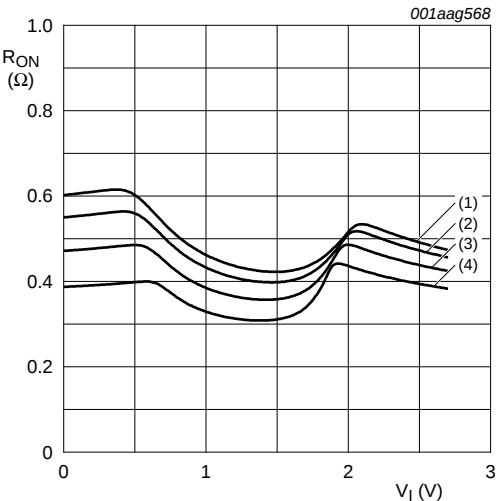
- (1)  $T_{amb} = 125\text{ }^{\circ}\text{C}.$
- (2)  $T_{amb} = 85\text{ }^{\circ}\text{C}.$
- (3)  $T_{amb} = 25\text{ }^{\circ}\text{C}.$
- (4)  $T_{amb} = -40\text{ }^{\circ}\text{C}.$

Fig 10. ON resistance as a function of input voltage;  
 $V_{CC} = 1.8\text{ V}$



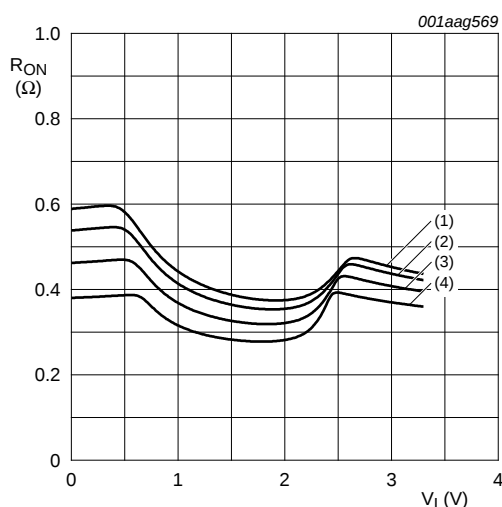
- (1)  $T_{amb} = 125\text{ }^{\circ}\text{C}.$
- (2)  $T_{amb} = 85\text{ }^{\circ}\text{C}.$
- (3)  $T_{amb} = 25\text{ }^{\circ}\text{C}.$
- (4)  $T_{amb} = -40\text{ }^{\circ}\text{C}.$

Fig 11. ON resistance as a function of input voltage;  
 $V_{CC} = 2.5\text{ V}$



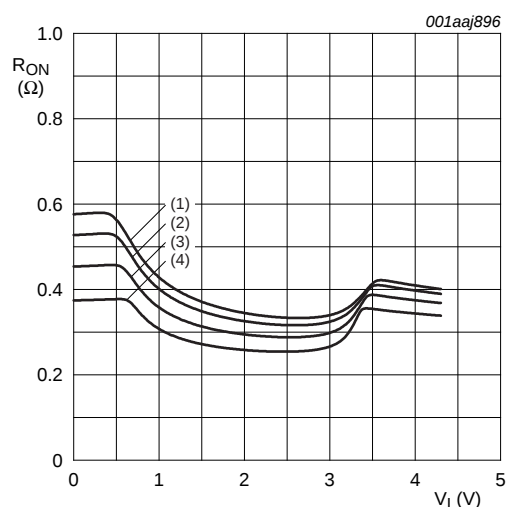
- (1)  $T_{amb} = 125\text{ }^{\circ}\text{C}.$
- (2)  $T_{amb} = 85\text{ }^{\circ}\text{C}.$
- (3)  $T_{amb} = 25\text{ }^{\circ}\text{C}.$
- (4)  $T_{amb} = -40\text{ }^{\circ}\text{C}.$

Fig 12. ON resistance as a function of input voltage;  
 $V_{CC} = 2.7\text{ V}$



- (1)  $T_{amb} = 125\text{ °C}$ .
- (2)  $T_{amb} = 85\text{ °C}$ .
- (3)  $T_{amb} = 25\text{ °C}$ .
- (4)  $T_{amb} = -40\text{ °C}$ .

**Fig 13.** ON resistance as a function of input voltage;  
 $V_{CC} = 3.3\text{ V}$



- (1)  $T_{amb} = 125\text{ °C}$ .
- (2)  $T_{amb} = 85\text{ °C}$ .
- (3)  $T_{amb} = 25\text{ °C}$ .
- (4)  $T_{amb} = -40\text{ °C}$ .

**Fig 14.** ON resistance as a function of input voltage;  
 $V_{CC} = 4.3\text{ V}$

## 12. Dynamic characteristics

**Table 9.** Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see [Figure 17](#).

| Symbol    | Parameter    | Conditions                                     | $T_{amb} = 25\text{ °C}$ |                    |     | $T_{amb} = -40\text{ °C to }+125\text{ °C}$ |             |              | Unit |
|-----------|--------------|------------------------------------------------|--------------------------|--------------------|-----|---------------------------------------------|-------------|--------------|------|
|           |              |                                                | Min                      | Typ <sup>[1]</sup> | Max | Min                                         | Max (85 °C) | Max (125 °C) |      |
| $t_{en}$  | enable time  | S to Z or Yn;<br>see <a href="#">Figure 15</a> |                          |                    |     |                                             |             |              |      |
|           |              | $V_{CC} = 1.4\text{ V to }1.6\text{ V}$        | -                        | 28                 | 43  | -                                           | 48          | 52           | ns   |
|           |              | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$      | -                        | 23                 | 35  | -                                           | 38          | 42           | ns   |
|           |              | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$        | -                        | 17                 | 27  | -                                           | 29          | 32           | ns   |
|           |              | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$        | -                        | 14                 | 25  | -                                           | 27          | 30           | ns   |
|           |              | $V_{CC} = 3.6\text{ V to }4.3\text{ V}$        | -                        | 14                 | 25  | -                                           | 27          | 30           | ns   |
| $t_{dis}$ | disable time | S to Z or Yn;<br>see <a href="#">Figure 15</a> |                          |                    |     |                                             |             |              |      |
|           |              | $V_{CC} = 1.4\text{ V to }1.6\text{ V}$        | -                        | 9                  | 20  | -                                           | 25          | 30           | ns   |
|           |              | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$      | -                        | 6                  | 15  | -                                           | 20          | 23           | ns   |
|           |              | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$        | -                        | 5                  | 11  | -                                           | 14          | 16           | ns   |
|           |              | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$        | -                        | 4                  | 10  | -                                           | 12          | 14           | ns   |
|           |              | $V_{CC} = 3.6\text{ V to }4.3\text{ V}$        | -                        | 4                  | 10  | -                                           | 12          | 14           | ns   |

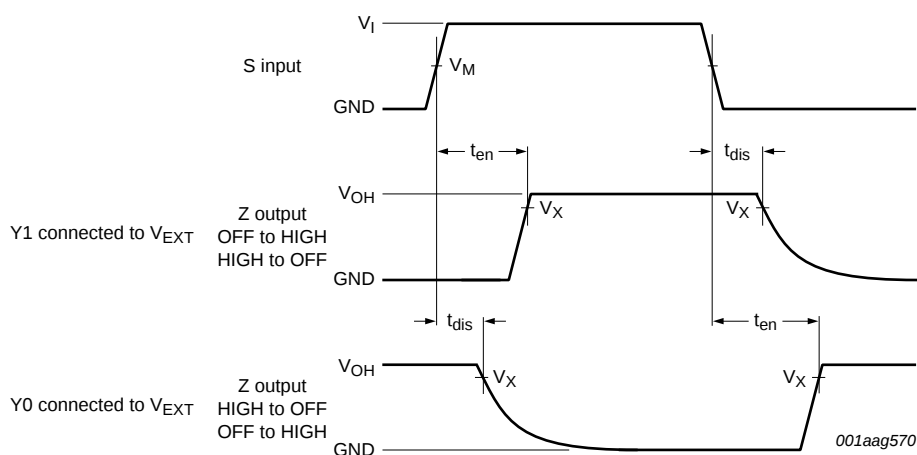
**Table 9. Dynamic characteristics ...continued**At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see [Figure 17](#).

| Symbol           | Parameter              | Conditions                                   | T <sub>amb</sub> = 25 °C |                    |     | T <sub>amb</sub> = -40 °C to +125 °C |             |              | Unit |
|------------------|------------------------|----------------------------------------------|--------------------------|--------------------|-----|--------------------------------------|-------------|--------------|------|
|                  |                        |                                              | Min                      | Typ <sup>[1]</sup> | Max | Min                                  | Max (85 °C) | Max (125 °C) |      |
| t <sub>b-m</sub> | break-before-make time | see <a href="#">Figure 16</a> <sup>[2]</sup> |                          |                    |     |                                      |             |              |      |
|                  |                        | V <sub>CC</sub> = 1.4 V to 1.6 V             | -                        | 19                 | -   | 4                                    | -           | -            | ns   |
|                  |                        | V <sub>CC</sub> = 1.65 V to 1.95 V           | -                        | 17                 | -   | 4                                    | -           | -            | ns   |
|                  |                        | V <sub>CC</sub> = 2.3 V to 2.7 V             | -                        | 13                 | -   | 2                                    | -           | -            | ns   |
|                  |                        | V <sub>CC</sub> = 2.7 V to 3.6 V             | -                        | 10                 | -   | 2                                    | -           | -            | ns   |
|                  |                        | V <sub>CC</sub> = 3.6 V to 4.3 V             | -                        | 10                 | -   | 2                                    | -           | -            | ns   |

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

## 12.1 Waveform and test circuits

Measurement points are given in [Table 10](#).Logic level: V<sub>OH</sub> is typical output voltage level that occurs with the output load.**Fig 15. Enable and disable times****Table 10. Measurement points**

| Supply voltage  | Input              | Output             |
|-----------------|--------------------|--------------------|
| V <sub>CC</sub> | V <sub>M</sub>     | V <sub>X</sub>     |
| 1.4 V to 4.3 V  | 0.5V <sub>CC</sub> | 0.9V <sub>OH</sub> |

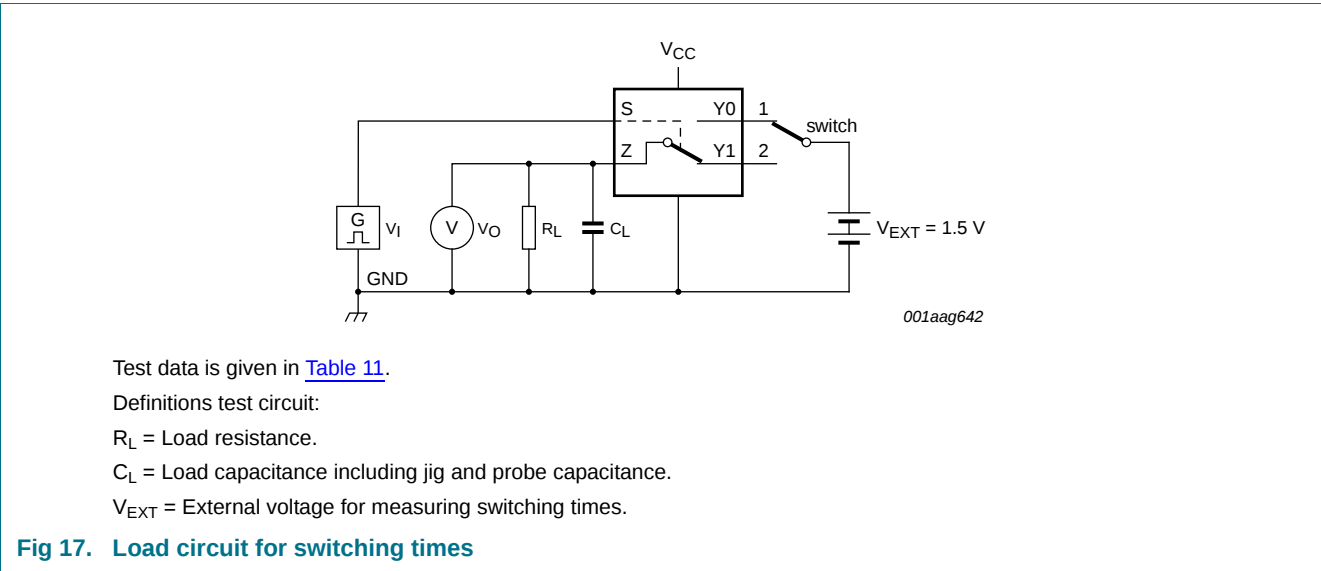
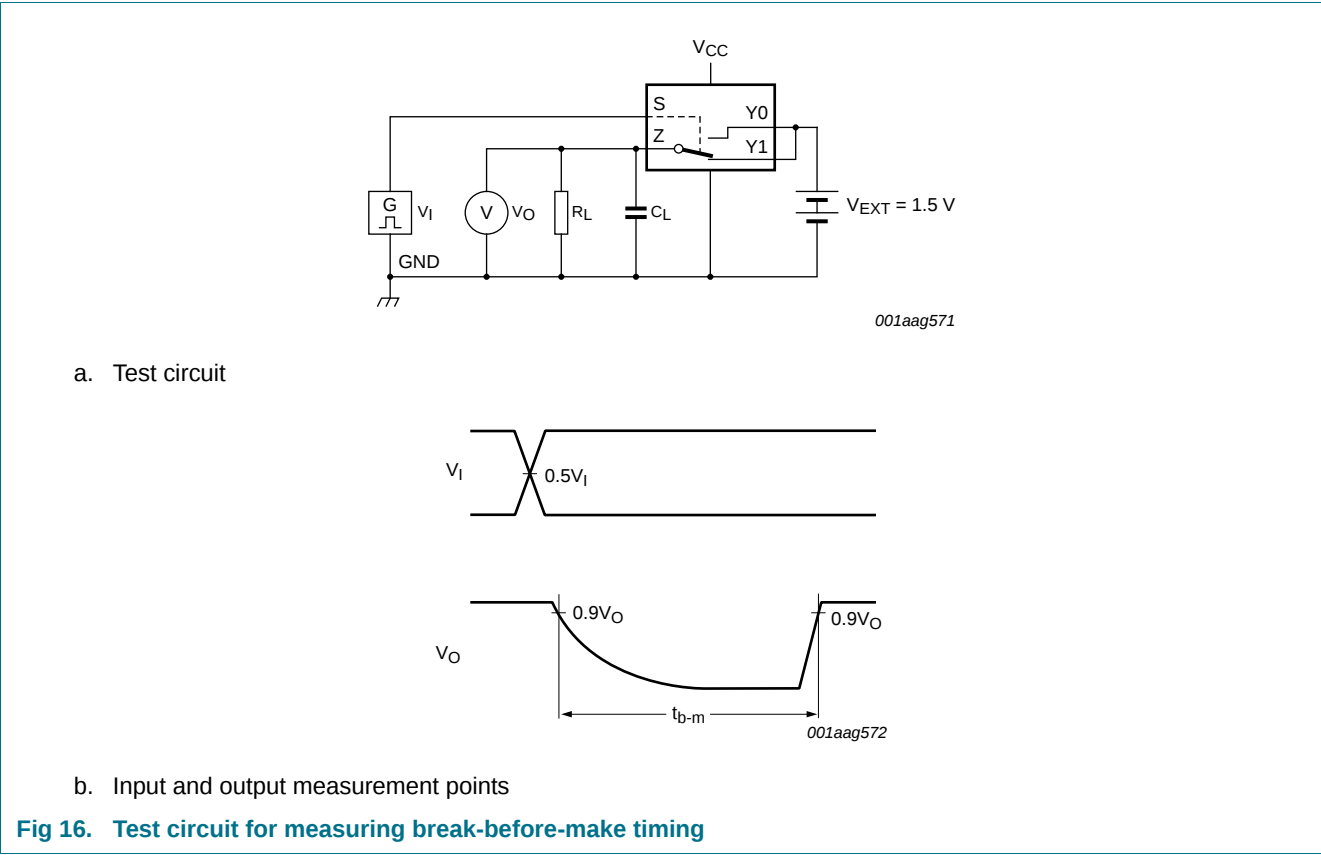


Table 11. Test data

| Supply voltage | Input    |                       | Load  |             |
|----------------|----------|-----------------------|-------|-------------|
| $V_{CC}$       | $V_I$    | $t_r, t_f$            | $C_L$ | $R_L$       |
| 1.4 V to 4.3 V | $V_{CC}$ | $\leq 2.5 \text{ ns}$ | 35 pF | 50 $\Omega$ |

## 12.2 Additional dynamic characteristics

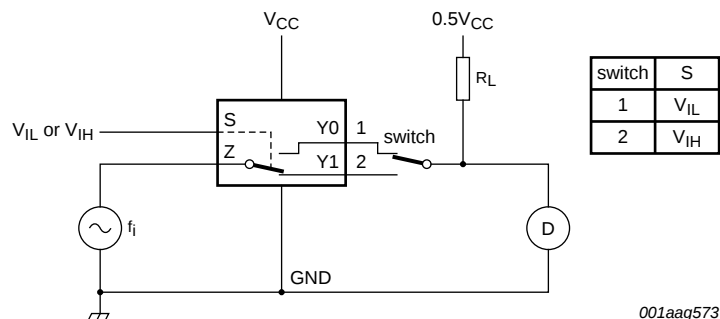
**Table 12. Additional dynamic characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_I = \text{GND or } V_{CC}$  (unless otherwise specified);  $t_r = t_f \leq 2.5 \text{ ns}$ ;  $T_{amb} = 25 \text{ }^\circ\text{C}$ .

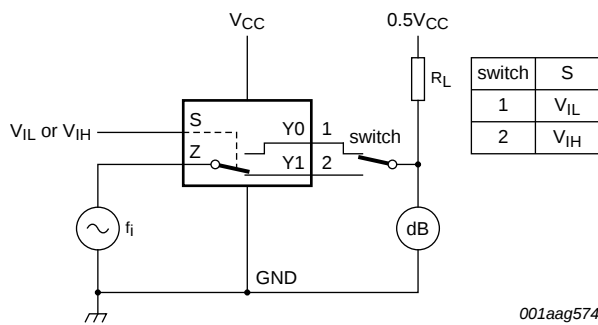
| Symbol              | Parameter                 | Conditions                                                                                                                                                              | Min | Typ  | Max | Unit |
|---------------------|---------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| THD                 | total harmonic distortion | $f_i = 20 \text{ Hz to } 20 \text{ kHz}$ ; $R_L = 32 \text{ } \Omega$ ; see <a href="#">Figure 18</a>                                                                   | [1] |      |     |      |
|                     |                           | $V_{CC} = 1.4 \text{ V}$ ; $V_I = 1 \text{ V (p-p)}$                                                                                                                    | -   | 0.15 | -   | %    |
|                     |                           | $V_{CC} = 1.65 \text{ V}$ ; $V_I = 1.2 \text{ V (p-p)}$                                                                                                                 | -   | 0.10 | -   | %    |
|                     |                           | $V_{CC} = 2.3 \text{ V}$ ; $V_I = 1.5 \text{ V (p-p)}$                                                                                                                  | -   | 0.02 | -   | %    |
|                     |                           | $V_{CC} = 2.7 \text{ V}$ ; $V_I = 2 \text{ V (p-p)}$                                                                                                                    | -   | 0.02 | -   | %    |
| $f_{(-3\text{dB})}$ | –3 dB frequency response  | $R_L = 50 \text{ } \Omega$ ; see <a href="#">Figure 19</a>                                                                                                              | [1] |      |     |      |
|                     |                           | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$                                                                                                                              | -   | 60   | -   | MHz  |
| $\alpha_{iso}$      | isolation (OFF-state)     | $f_i = 100 \text{ kHz}$ ; $R_L = 50 \text{ } \Omega$ ; see <a href="#">Figure 20</a>                                                                                    | [1] |      |     |      |
|                     |                           | $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$                                                                                                                              | -   | –90  | -   | dB   |
| $V_{ct}$            | crosstalk voltage         | between digital inputs and switch;<br>$f_i = 1 \text{ MHz}$ ; $C_L = 50 \text{ pF}$ ; $R_L = 50 \text{ } \Omega$ ; see <a href="#">Figure 21</a>                        |     |      |     |      |
|                     |                           | $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$                                                                                                                              | -   | 0.2  | -   | V    |
|                     |                           | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$                                                                                                                              | -   | 0.3  | -   | V    |
| $Q_{inj}$           | charge injection          | $f_i = 1 \text{ MHz}$ ; $C_L = 0.1 \text{ nF}$ ; $R_L = 1 \text{ M}\Omega$ ; $V_{gen} = 0 \text{ V}$ ;<br>$R_{gen} = 0 \text{ } \Omega$ ; see <a href="#">Figure 22</a> |     |      |     |      |
|                     |                           | $V_{CC} = 1.5 \text{ V}$                                                                                                                                                | -   | 3    | -   | pC   |
|                     |                           | $V_{CC} = 1.8 \text{ V}$                                                                                                                                                | -   | 4    | -   | pC   |
|                     |                           | $V_{CC} = 2.5 \text{ V}$                                                                                                                                                | -   | 6    | -   | pC   |
|                     |                           | $V_{CC} = 3.3 \text{ V}$                                                                                                                                                | -   | 9    | -   | pC   |
|                     |                           | $V_{CC} = 4.3 \text{ V}$                                                                                                                                                | -   | 15   | -   | pC   |

[1]  $f_i$  is biased at  $0.5V_{CC}$ .

## 12.3 Test circuits

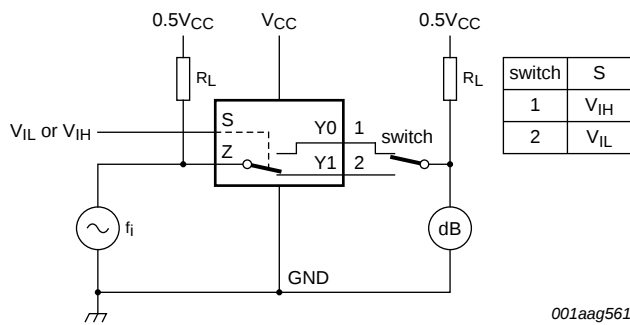


**Fig 18. Test circuit for measuring total harmonic distortion**



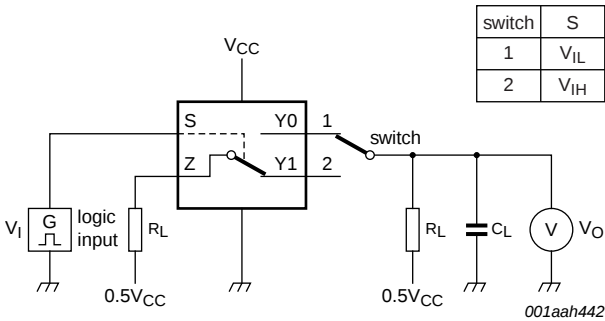
Adjust  $f_i$  voltage to obtain 0 dBm level at output. Increase  $f_i$  frequency until dB meter reads -3 dB.

Fig 19. Test circuit for measuring the frequency response when channel is in ON-state

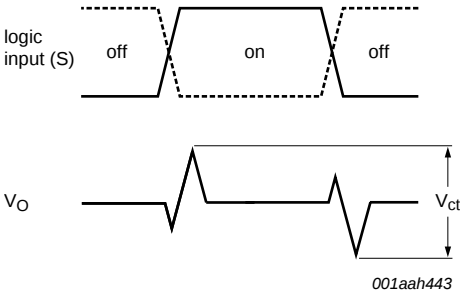


Adjust  $f_i$  voltage to obtain 0 dBm level at input.

Fig 20. Test circuit for measuring isolation (OFF-state)

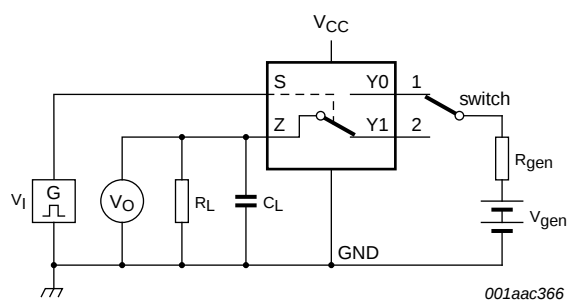


a. Test circuit

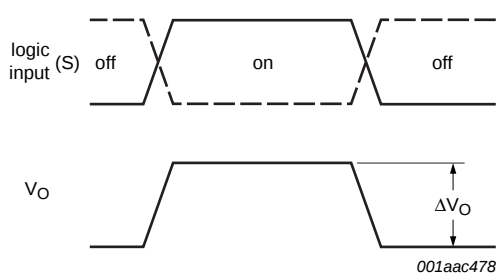


b. Input and output pulse definitions

Fig 21. Test circuit for measuring crosstalk voltage between digital inputs and switch



a. Test circuit



b. Input and output pulse definitions

Definition:  $Q_{inj} = \Delta V_O \times C_L$ .

$\Delta V_O$  = output voltage variation.

$R_{gen}$  = generator resistance.

$V_{gen}$  = generator voltage.

**Fig 22. Test circuit for measuring charge injection**

13. Package outline

Plastic surface-mounted package; 6 leadsSOT363

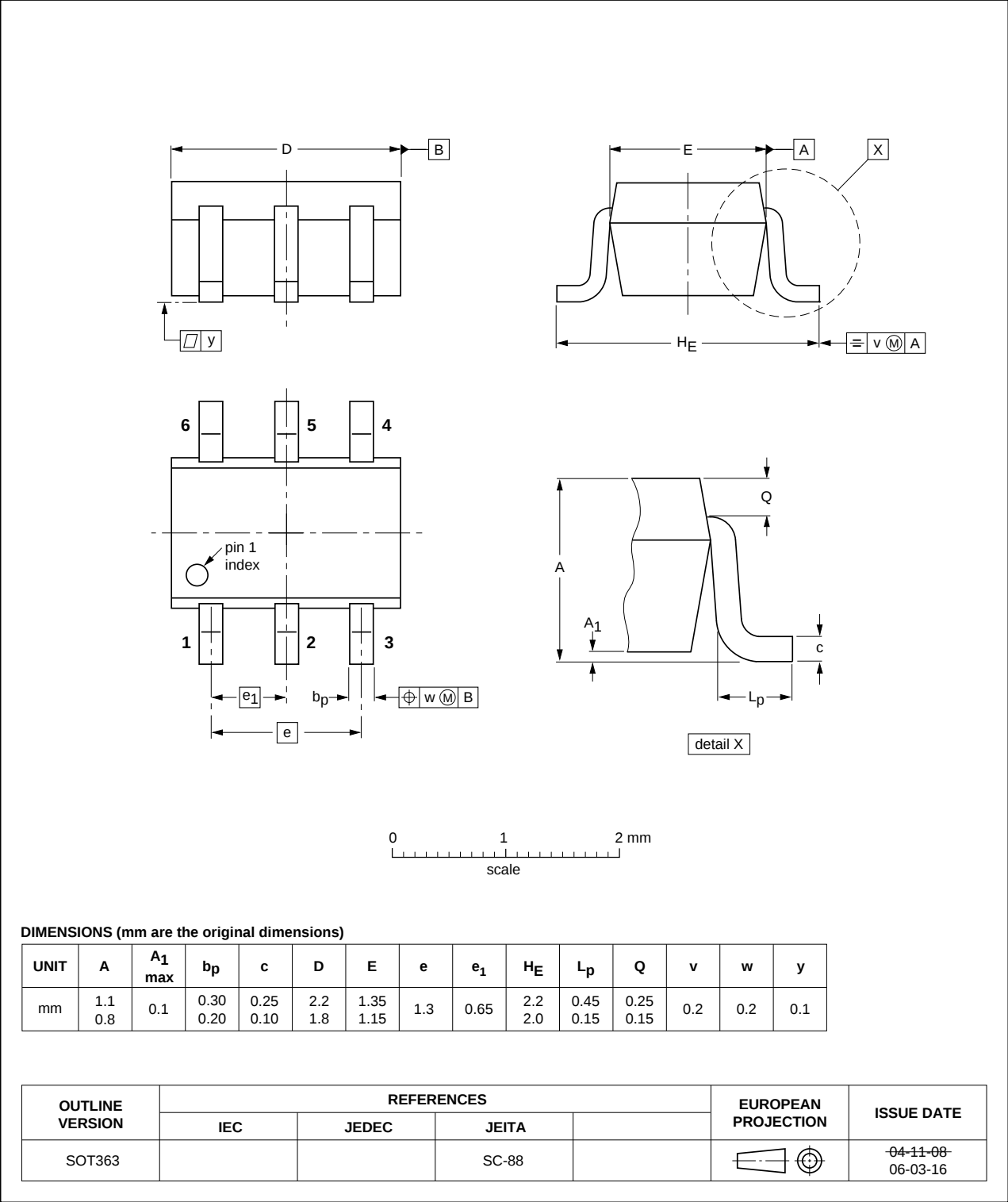


Fig 23. Package outline SOT363 (SC-88)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886

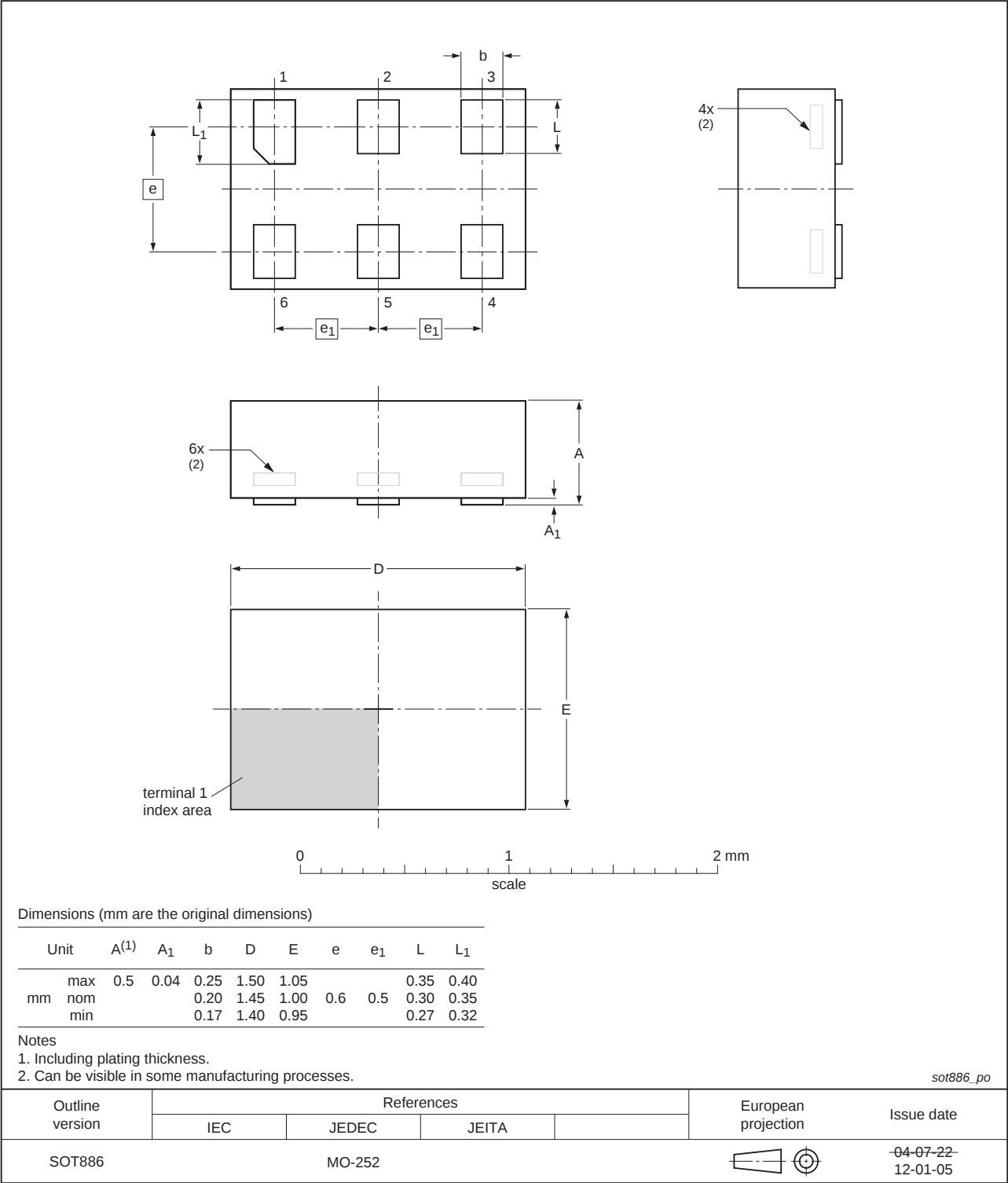


Fig 24. Package outline SOT886 (XSON6)

## 14. Abbreviations

Table 13. Abbreviations

| Acronym | Description                             |
|---------|-----------------------------------------|
| CDM     | Charged Device Model                    |
| CMOS    | Complementary Metal-Oxide Semiconductor |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| PDA     | Personal Digital Assistant              |
| TTL     | Transistor-Transistor Logic             |

## 15. Revision history

Table 14. Revision history

| Document ID     | Release date                                                                | Data sheet status  | Change notice | Supersedes     |
|-----------------|-----------------------------------------------------------------------------|--------------------|---------------|----------------|
| NX3L1G3157 v.10 | 20120807                                                                    | Product data sheet | -             | NX3L1G3157 v.9 |
| Modifications:  | • Package outline drawing of SOT886 ( <a href="#">Figure 24</a> ) modified. |                    |               |                |
| NX3L1G3157 v.9  | 20111109                                                                    | Product data sheet | -             | NX3L1G3157 v.8 |
| Modifications:  | • Legal pages updated.                                                      |                    |               |                |
| NX3L1G3157 v.8  | 20100426                                                                    | Product data sheet | -             | NX3L1G3157 v.7 |
| NX3L1G3157 v.7  | 20100324                                                                    | Product data sheet | -             | NX3L1G3157 v.6 |
| NX3L1G3157 v.6  | 20100208                                                                    | Product data sheet | -             | NX3L1G3157 v.5 |
| NX3L1G3157 v.5  | 20090407                                                                    | Product data sheet | -             | NX3L1G3157 v.4 |
| NX3L1G3157 v.4  | 20080730                                                                    | Product data sheet | -             | NX3L1G3157 v.3 |
| NX3L1G3157 v.3  | 20080721                                                                    | Product data sheet | -             | NX3L1G3157 v.2 |
| NX3L1G3157 v.2  | 20080415                                                                    | Product data sheet | -             | NX3L1G3157 v.1 |
| NX3L1G3157 v.1  | 20071008                                                                    | Product data sheet | -             | -              |

## 16. Legal information

### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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